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'90A,	'LS90 Decade Counters
′92A,	LS92 Divide By-Twelve Counters
'93A,	LS93 4-Bit Binary Counters

TVOCO	TYPICAL
TYPES	POWER DISSIPATION
'90A	145 mW
'92A, '93A	130 mW
LS90, LS92, LS93	45 mW

description

Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a threestage binary counter for which the count cycle length is divide-by-five for the '90A and 'LS90, divide-by-six for the '92A and 'LS92, and the divide-by-eight for the '93A and 'LS93.

All of these counters have a gated zero reset and the '90A and 'LS90 also have gated set-to-nine inputs for use in BCD nine's complement applications.

To use their maximum count length (decade, divide-by-twelve, or four-bit binary) of these counters, the CKB input is connected to the Q_A output. The input count pulses are applied to CKA input and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '90A or 'LS90 counters by connecting the Q_D output to the CKA input and applying the input count to the CKB input which gives a divide-by-ten square wave at output Q_A .

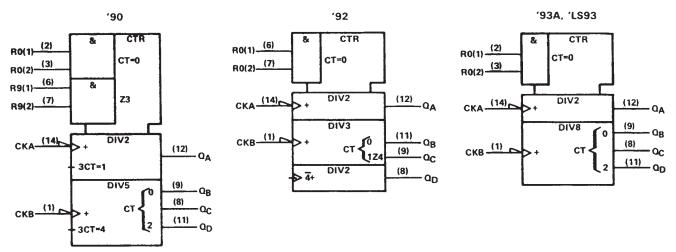
SN5490A, SN54LS90 J OR W PACKAGE SN7490A N PACKAGE SN74LS90 D OR N PACKAGE (TOP VIEW)
CKB 1 14 CKA R0(1) 2 13 NC R0(2) 3 12 Q_A NC 4 11 Q_D V _{CC} 5 10 GND R9(1) 6 9 Q_B R9(2) 7 8 Q_C
SN5492A, SN54LS92 J OR W PACKAGE SN7492A N PACKAGE SN74LS92 D OR N PACKAGE (TOP VIEW)
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
SN5493A, SN54LS93 J OR W PACKAGE SN7493 N PACKAGE SN74LS93 D OR N PACKAGE (TOP VIEW)
CKB 1 14 CKA R0(1) 2 13 NC R0(2) 3 12 QA NC 4 11 QD VCC 5 10 GND NC 6 9 QB NC 7 8 QC

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS SDLS940A – MARCH 1974 – REVISED MARCH 1988

logic symbols[†]



[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.



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'90A, 'LS90 BI-QUINARY (5-2)												
(See Note B)												
COUNT OUTPUT												
	QA	QD	ac	QB								
0	L	L	E	L								
1	L	L	Ł	н								
2	с с н		LH									
3	L	L	н	н								
4	L	н	L	L								
5	н	L	L	L								
6	н	L	L	н								
7	н	н с н		L								
8	н	L	н	н								
9	н	н	L	L								

'90A, 'LS90 **RESET/COUNT FUNCTION TABLE**

RESET INPUTS					ουτ	PUT	
R ₀₍₁₎	R0(2)	R ₉₍₁₎	R9(2)	۵ _D	QC	QB	QA
н	н	L	X	L	L	L	L
н	н	×	L	L	L	L	L
×	×	н	н	н	L	L	н
×	L	×	L		со	UNT	
L	×	L	х		со	UNT	
L	×	х	L		со	UNT	
x	L	L	х		со	UNT	

'93A, 'LS93 COUNT SEQUENCE

(See Note C)											
COUNT		ουτ	PUT								
COONT	QD	ac	٥ _B	QA							
0	L	L	L	L							
1	L	L	Ł	н							
2	L	L	н	L							
3	L	L	н	н							
4	L	н	L	L							
5	L	н	L	н							
6	L	н	н	L							
7	L	н	н	н							
8	н	L	L	L							
9	н	L	L	н							
10	н	L	н	L							
11	н	L	н	н							
12	н	н	L	L							
13	н	н	L	н							
14	н	н	н	L							
15	н	н	н	н							

'90A, 'LS90 BCD COUNT SEQUENCE (See Note A)

(See Note A)																		
COUNT	OUTPUT										OUTPUT							
COONT	٥D	QD QC QB																
0	L	L	L	L														
1	L	L	L	н														
2	с с н		LН															
3	L	L	Н	н														
4	L	н	L	- L														
5	L	н	L	н														
6	L H H L H H			L														
7				с н н		с н н		с н н		с н н		нн						
8	н	L	L	L														
9	н	L	L	н														

'92A, 'LS92 COUNT SEQUENCE (See Note C)

(266	NOTE	C)

COUNT		τυο	PUT	
COUNT	QD	QC	QB	QA
0	L	L	L	L
1	L	L	L	н
2	L	L	н	L
3	L	£	н	н
4	L	н	L	L
5	L	н	L	н
6	н	Ł	L	L
7	н	L	L	н
8	н	L	н	L
9	н	L	н	н
10	н	н	L	L
11	н	н	L	н

'92A, 'LS92, '93A, 'LS93 **RESET/COUNT FUNCTION TABLE**

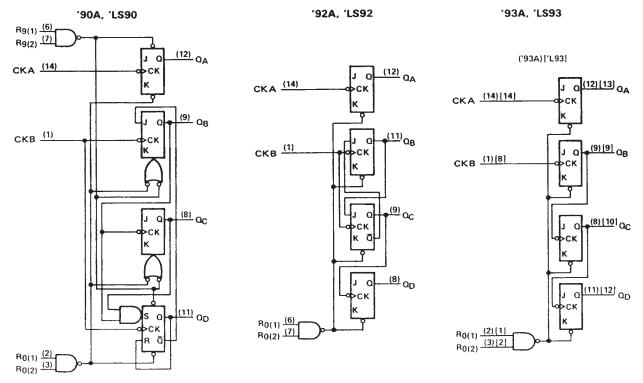
nese	1/COUNT	FUNC	21101	IADI	-6		
RESET	OUTPUT						
R ₀₍₁₎	R ₀₍₂₎	QD	a c	QB	QA		
н	Н	L	L	L	L		
L	х		CO	JNT			
x	L		CO	JNT			

- NOTES: A. Output \mathbf{Q}_{A} is connected to input CKB for BCD count. B. Output Q_D is connected to input CKA for bi-quinary
 - count.
 - C. Output O_A is connected to input CKB.
 - D. H = high level, L = low level, X = irrelevant



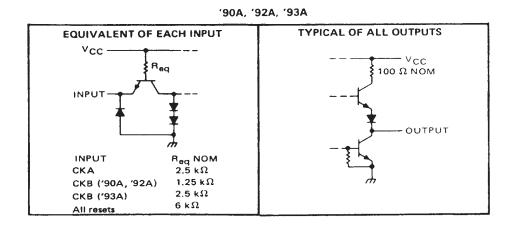
SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS SDLS940A – MARCH 1974 – REVISED MARCH 1988

logic diagrams (positive logic)



The J and K inputs shown without connection are for reference only and are functionally at a high level. Pin numbers shown in () are for the 'LS93 and '93A and pin numbers shown in [] are for the 54L93.

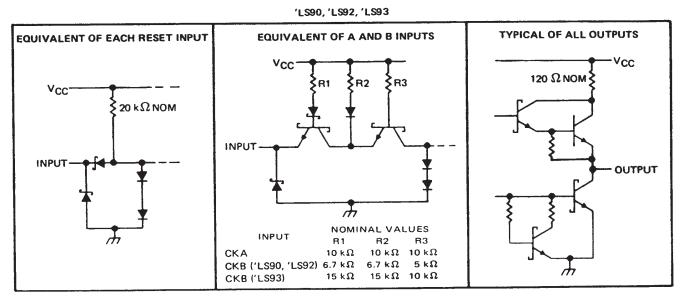
schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)								•	•	 				•	. 7V
Input voltage															
Interemitter voltage (see Note 2)										 					. 5.5 V
Operating free-air temperature range:	SN5490A	SN549	02A, S	SN549	3A					 		-5	5°	C t	o 125°C
Shorarung une zu tembereren 3.	SN7490A	SN749)2A, S	SN749	3A					 			0	°C	to 70°C
Storage temperature range								•		 		-6	5°	C t	o 1 50° C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R₀ inputs, and for the '90A circuit, it also applies between the two R₉ inputs.

recommended operating conditions

		1	0A, SN SN5493		SN749	7492A A	UNIT		
		MIN NOM MAX MIN NOM					MAX		
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, ¹ OH				-800			-800	μA	
Low-level output current, IOL				16			16	mA	
	A input	0		32	0		32	MHz	
Count frequency, fcount (see Figure 1)	B input	0		16	0		16		
	A input	15			15				
Pulse width, tw	B input	30			30			ns	
	Reset inputs	15			15				
Reset inactive-state setup time, t _{su}		25			25			ns	
Operating free-air temperature, TA		-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

						'90A			'92A			'93A		UNIT
	PARAMETE	R [¶]	TEST CONDITIO	DNST	MIN	TYP	MAX	MIN	ТҮР‡	MAX	MIN	ΤΥΡ ‡	MAX	UNIT
ViH	High-level inpu	t voltage			2			2			2			V
VIL	Low-level inpu		· · · · · · · · · · · · · · · · · · ·				0.8			0.8			0.8	V
VIK	Input clamp vo		$V_{CC} = MIN, I_{I} = -1$	2 mA			-1.5			-1.5			-1.5	V
	High-level out		V _{CC} = MIN, V _{IH} = 2 V _{IL} = 0.8 V, I _{OH} = 2	2 V,	2.4	3.4		2.4	3.4		2.4	3.4		v
VOL	Low-level outp	out voltage	V _{CC} = MIN, V _{IH} = 2 V _{IL} = 0.8 V, I _{OL} =	2 V,		0.2	0.4		0.2	0.4		0.2	0.4	v
4	Input current maximum inp		V _{CC} = MAX, V ₁ = 5.	5 V			1			1			1	mA
		Any reset					40			40			40	
Чн	High-level	СКА	$V_{CC} = MAX, V_1 = 2.$	4 V			80			80			80	μA
	input current	СКВ					120			120			80	L
		Any reset			T		-1.6			-1.6			-1.6	1
μĽ	Low-level	СКА	V _{CC} = MAX, V _I = 0.	.4 V			-3.2			-3.2			-3.2	MA
	input current	СКВ	1 .				-4.8			-4.8			-3.2	
	Short-circuit			SN54'	-20		-57	-20		-57	-20		-57	mA
los	output curren	tŠ	V _{CC} = MAX	SN74'	-18		-57	-18		-57	-18		57	
1cc	Supply curren		V _{CC} = MAX, See No	ote 3		29	42		26	39		26	39	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25$ °C.

SNot more than one output should be shorted at a time.

 ${}^{(1)}Q_A$ outputs are tested at I_{OL} = 16 mA plus the limit value for I_{1L} for the CKB input. This permits driving the CKB input while maintaining full fan out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R₀ inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



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switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	FROM	то			'90A			'92A			'93A		
PARAMETER [†]	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	түр	MAX	MIN	ТҮР	MAX	MIN	ΤΥΡ	MAX	
	СКА	۵ _A		32	42		32	42		32	42		MHz
f _{max}	СКВ	QB		16			16			16			
tPLH	СКА	0.			10	16		10	16		10	16	ns
tPHL		۵ _A			12	18		12	18		12	18	
tPLH		0			32	48		32	48		46	70	ns
tPHL	СКА	۵D			34	50		34	50		46	70	
tPLH		-	CL = 15 pF,		10	16		10	16		10	16	ns
tPHL	СКВ	QB	R _L = 400 Ω,		14	21		14	21		14	21	
tPLH			See Figure 1		21	32		10	16		21	32	ns
tPHL	СКВ	QC			23	35		14	21		23	35] ""
tPLH		_	1		21	32	1	21	32		34	51	ns
19HL	СКВ	ΩD			23	35	1	23	35		34	51	
tPHL	Set-to-0	Any	1		26	40		26	40		26	40	ns
tPLH		Q _A , Q _D	1		20	30	1						- ns
TPHL	Set-to-9	O _B , Q _C	1		26	40	Γ						

[†]f_{max} = maximum count frequency

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .			 	7V
Input voltage: R inputs			 	7 V
A and B inputs			 	5.5 V
Operating free-air temperature range:	SN54LS	Circuits	 	–55°C to 125°C
	SN74LS	Circuits	 	0°C to 70°C
Storage temperature range			 	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	SN54LSS SN54LSS SN54LSS	92	5	SN74LS SN74LS SN74LS	92	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	1
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-400			-400	μA
Low-level output current, IOL				4			8	mA
Count from the from Figure 1)	A input	0		32	0		32	MHz
Count frequency, f _{count} (see Figure 1)	B input	0		16	0		16	
	A input	15			15			
Pulse width, tw	B input	30			30			ns
	Reset inputs	30			30			1
Reset inactive-state setup time, t _{su}		25			25			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMET	TER	TEST CONDITIONS [†]			1	N54LS9 N54LS9		_	N74LS9		UNIT
						MIN	TYP [‡]	MAX	MIN	TYP‡	MAX	
VIH	High-level inpu	t voltage				2			2			V
VIL	Low-level input	t voltage						0.7			0.8	v
VIK	Input clamp vo	ltage	V _{CC} = MIN,	lı = -18 mA				-1.5			-1.5	V
VOH	High-level outp	ut voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400 μA	Ą	2.5	3.4		2.7	3.4		v
VOL	Low-level outp	ut voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V,	IOL = 4 mA¶		0.25	0.4		0.25 0.35	0.4 0.5	v
	Input current	Any reset	V _{CC} = MAX,	V1 = 7 V				0.1			0.1	
11	at maximum	СКА						0.2			0.2	mA
	input voltage	СКВ	$V_{CC} = MAX,$	VI = 5.5 V				0.4			0.4	
	High-level	Any reset						20			20	
Чн	input current	СКА	V _{CC} = MAX,	VI = 2.7 V				40			40	μA
	«iput cuireitt	СКВ]					80			80	
	Low-level	Any reset						-0.4			-0.4	
ΗL	input current	СКА	V _{CC} = MAX,	V _I = 0.4 V				-2.4			-2.4	mA
	Input current	СКВ						-3.2			-3.2	L
los	Short-circuit ou	utput current §	V _{CC} = MAX			-20		-100	-20		-100	mΑ
100	Supply current		V _{CC} = MAX,	See Note 3	'LS90		9	15		9	15	mA
lcc	Supply cultent		VCC - WAA,	Jee Note 3	'LS92		9	15		9	15	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

 \S Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

IQA outputs are tested at specified IOL plus the limit value of IL for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_O inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					~ +	s	N54LS	13	S	N74LS9)3	
	PARAMET	TER	TE	ST CONDITION	5'	MIN	TYP [‡]	MAX	MIN	түр‡	MAX	UNIT
ViH	High-level inpu	t voltage				2			2			V
VIL	Low-level input							0.7			0.8	V
VIK	Input clamp vo	Itage	V _{CC} = MIN,	l _l = -18 mA				-1.5			-1.5	V
Vон	High-level outp	ut voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400 µA	A	2.5	3.4		2.7	3.4		v
			V _{CC} = MIN,	VIH = 2 V,	10L = 4 mA 1		0.25	0.4		0.25	0.4	v
VOL	Low-level outp	ut voltage	VIL = VIL max		IOL = 8 mA¶					0.35	0.5	
	Input current	Any reset	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
4	at maximum input voltage	CKA or CKB	V _{CC} = MAX,	V1 = 5.5 V				0.2			0.2	
	High-level	Any reset		N(= 2.7.V)				20			20	μΑ
чн	input current	CKA or CKB	V _{CC} = MAX,	V ₁ = 2.7 V				40			80	<u><u></u></u>
		Any reset						-0.4			-0.4	
IIL.	Low-level	СКА	V _{CC} = MAX,	VI = 0.4 V				-2.4			-2.4	mA
	input current	СКВ	1					-1.6			-1.6	
los	Short-circuit of	utput current §	V _{CC} = MAX			-20		-100	-20		-100	mA
ICC	Supply current		V _{CC} = MAX,	See Note 3			9	15		9	15	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

 \P_{a} outputs are tested at specified IOL plus the limit value for IIL for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: ICC is measured with all outputs open, both Ro inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	FROM	то			'LS90)		'LS92			'LS93		UNIT
PARAMETER#	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	ТҮР	мах	MIN	түр	MAX	MIN	TYP	MAX	0.411
	СКА	QA		32	42		32	42		32	42		MHz
f _{max}	СКВ	QB		16			16			16			
1PLH	014.0	0			10	16		10	16		10	16	ns
1PHL	СКА	QA			12	18		12	18		12	18	
^t PLH	СКА	0-			32	48		32	48		46	70	ns
^t PHL		۵D			34	50		34	50		46	70	
1PLH	014.0	0-	CL = 15 pF,		10	16		10	16		10	16	ns
^t PHL	СКВ	QB	RL = 2 kΩ		14	21		14	21		14	21	
1PLH	01/0	0	See Figure 1		21	32		10	16		21	32	ns
^t PHL	СКВ	ac			23	35		14	21		23	35	
TPLH	01/15	0]		21	32		21	32		34	51	ns
TPHL	СКВ	۵D			23	35		23	35		34	51	
19HL	Set-to-0	Any	1		26	40		26	40		26	40	ns
^t PLH	6	QA, QD]		20	30							ns
^t PHL	Set-to-9	QB, QC]		26	40							

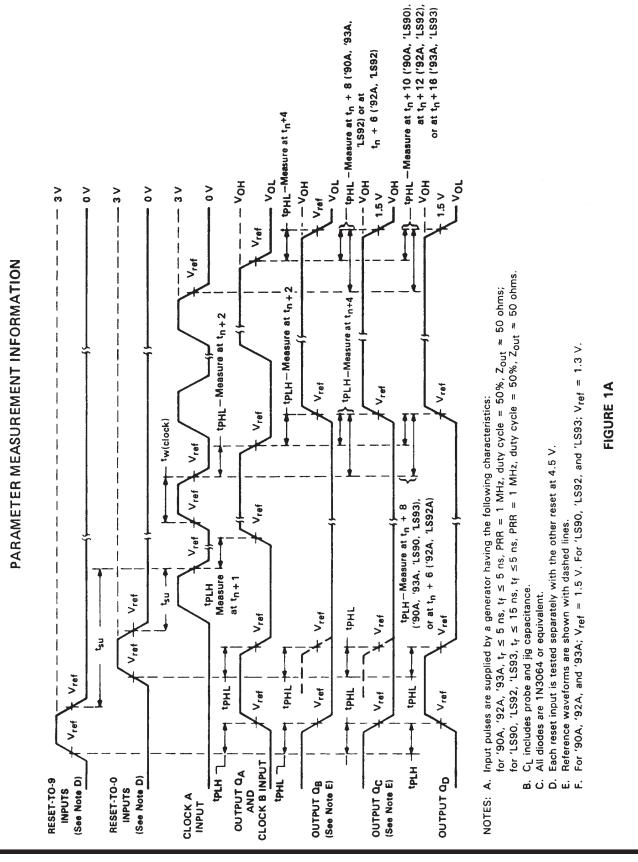
#fmax = maximum count frequency

tPLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output



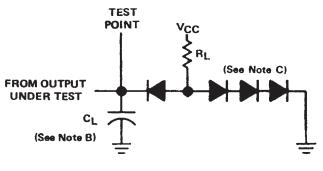
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PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

- NOTES: A. Input pulses are supplied by a generator having the following characteristics: for '90A, '92A, '93A, $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms; for 'LS90, 'LS92, 'LS93, $t_r \le 15$ ns, $t_f \le 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
 - B. CL includes probe and jig capacitance.
 - C. All diodes are 1N3064 or equivalent.
 - D. Each reset input is tested separately with the other reset at 4.5 V.
 - E. Reference waveforms are shown with dashed lines.
 - F. For '90A, '92A, and '93A; V_{ref} = 1.5 V. For 'LS90, 'LS92, and 'LS93; V_{ref} = 1.3 V.

FIGURE 1B



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PACKAGING INFORMATION

	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
7603201CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
7603201DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
7700101CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
7700101DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
JM38510/31501BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
JM38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SN5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN7490AN	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN7492AN	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN7493AN	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS90D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS90NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92N3	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS92NE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	ACTIVE	SO	NS	14	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92NSRE4						no Sb/Br)		

PACKAGE OPTION ADDENDUM

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STRUMENTS

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74LS93D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS93N3	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS93NE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS93NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5490AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5492AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS90W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS93W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)



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11-Nov-2009

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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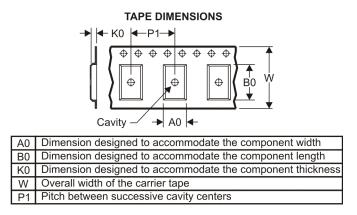
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS90DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS92NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS93DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS93NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

29-Jul-2009



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS90DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74LS92NSR	SO	NS	14	2000	346.0	346.0	33.0
SN74LS93DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74LS93NSR	SO	NS	14	2000	346.0	346.0	33.0

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE

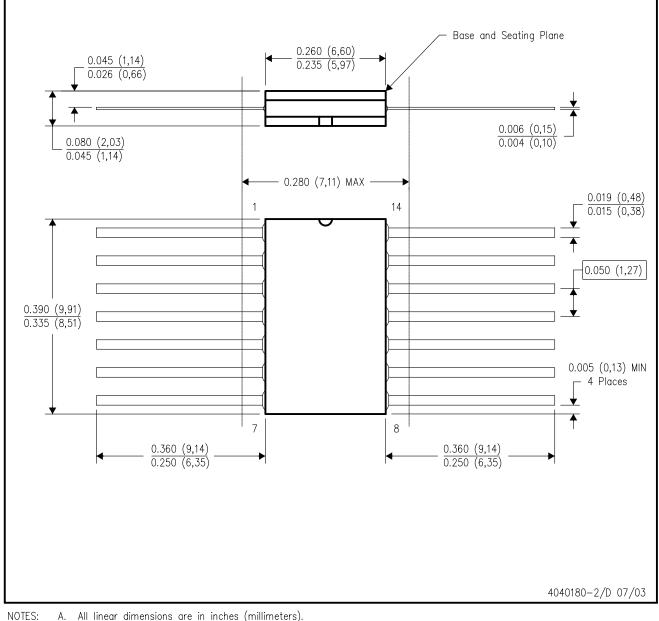


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

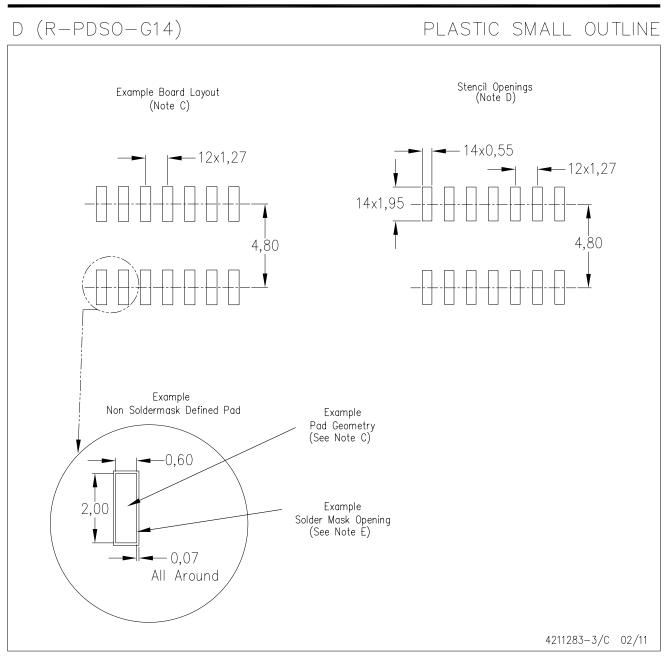
PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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